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December 2012

FDMS2572 N-Channel UltraFET Trench[®] MOSFET 150V, 27A, 47mΩ

Features

- Max $r_{DS(on)}$ = 47m Ω at V_{GS} = 10V, I_D = 4.5A
- Max $r_{DS(on)}$ = 53m Ω at V_{GS} = 6V, I_D = 4.5A
- Low Miller Charge
- Optimized efficiency at high frequencies
- UIS Capability (Single pulse and Repetitive pulse)
- RoHS Compliant

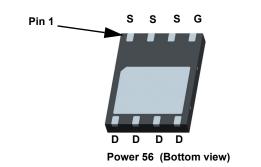


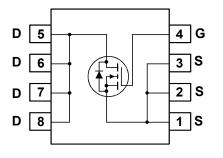
General Description

UltraFET devices combine characteristics that enable benchmark efficiency in power conversion applications. Optimized for $r_{DS(on)}$, low ESR, low total and Miller gate charge, these devices are ideal for high frequency DC to DC converters.

Application

- Distributed Power Architectures and VRMs
- Primary Switch for 24V and 48V Systems
- High Voltage Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25°C		27		
	-Continuous (Silicon limited)	T _C = 25°C		27	А	
	-Continuous	T _A = 25°C	(Note 1a)	4.5		
	-Pulsed			30		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	150	mJ	
P _D	Power Dissipation	T _C = 25°C		78	14/	
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)		(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

Thermal Characteristics

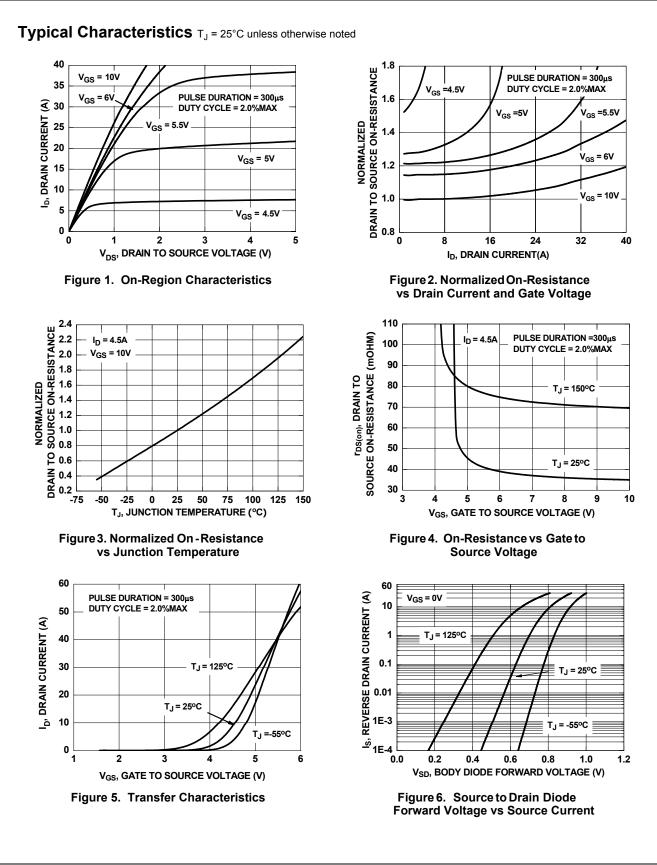
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.6	°C/W
$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient (Not	te 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS2572	FDMS2572	Power 56	13"	12mm	3000 units

FDMS2572 N-Channel UltraFET Trench[®] MOSFET

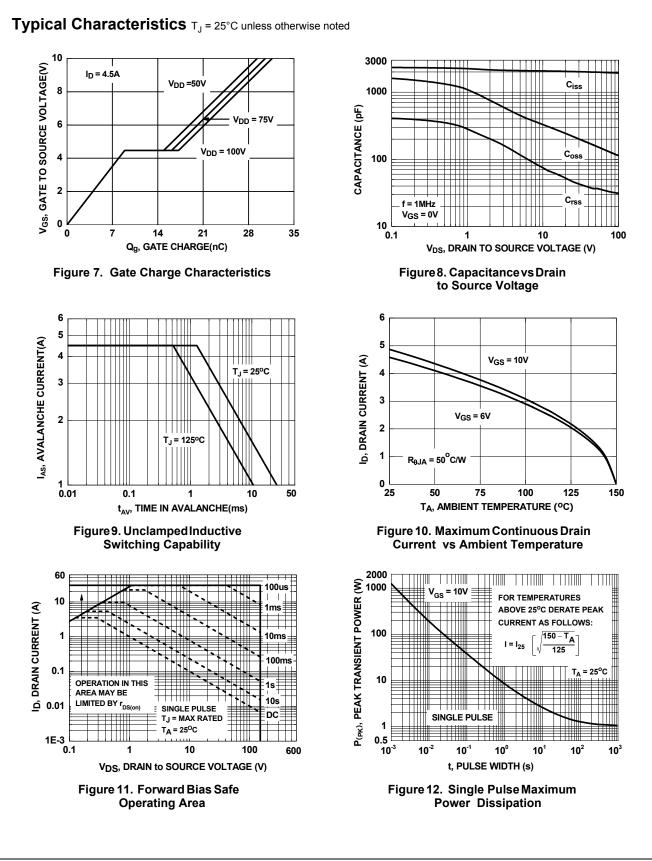
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		180		mV/°C
	Zero Gate Voltage Drain Current	V _{DS} = 120V, V _{GS} = 0V			1	μA
I _{DSS} I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
				_ 		
	cteristics (Note 2)			1	1	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	3	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-9.8		mV/°C
		V _{GS} = 10V, I _D = 4.5A		36	47	
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 6V, I_D = 4.5A$		39	53	mΩ
		V_{GS} = 10V, I_D = 4.5A, T_J = 125°C		69	103	
9 _{FS}	Forward Transconductance	V _{DS} = 10V, I _D = 4.5A		14		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1960	2610	pF
C _{oss}	Output Capacitance	$-V_{DS} = 75V, V_{GS} = 0V,$		130	175	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		30	45	pF
R _q	Gate Resistance	f = 1MHz	0.1	1.3	2.6	Ω
d(on)	g Characteristics Turn-On Delay Time Rise Time	V _{DD} = 75V, I _D = 1.0A V _{GS} = 10V, R _{GEN} = 6Ω		11 8	20 16	ns ns
t _r	Turn-Off Delay Time			38	61	ns
t _{d(off)} t	Fall Time			30	50	ns
t _f	Total Gate Charge at 10V	$V_{res} = 0V_{res} t_0 10V_{res}$		31	43	nC
Q _{g(TOT)}	Gate to Source Gate Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 75V$ $I_D = 4.5A$		9	40	nC
Q _{gs} Q _{gd}	Gate to Drain "Miller" Charge	iD - 4.0A		7		nC
Drain-So	urce Diode Characteristics				I	1
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.2A$ (Note 2)		0.7	1.0	V
t _{rr}	Reverse Recovery Time	— I _F = 4.5A, di/dt = 100A/μs		67	101	ns
Q _{rr} Notes: I: R _{θJA} is deterr the user's box	Reverse Recovery Charge mined with the device mounted on a 1in ² pad 2 oz copper pa ard design.		guaranteed	130 by design wh	195 nile R _{0CA} is d	nC letermined
	a.50°C/W when mount a 1 in ² pad of 2 oz copp	ied on mir		en mounted of 2 oz coppe		
	00000 00000	00000				



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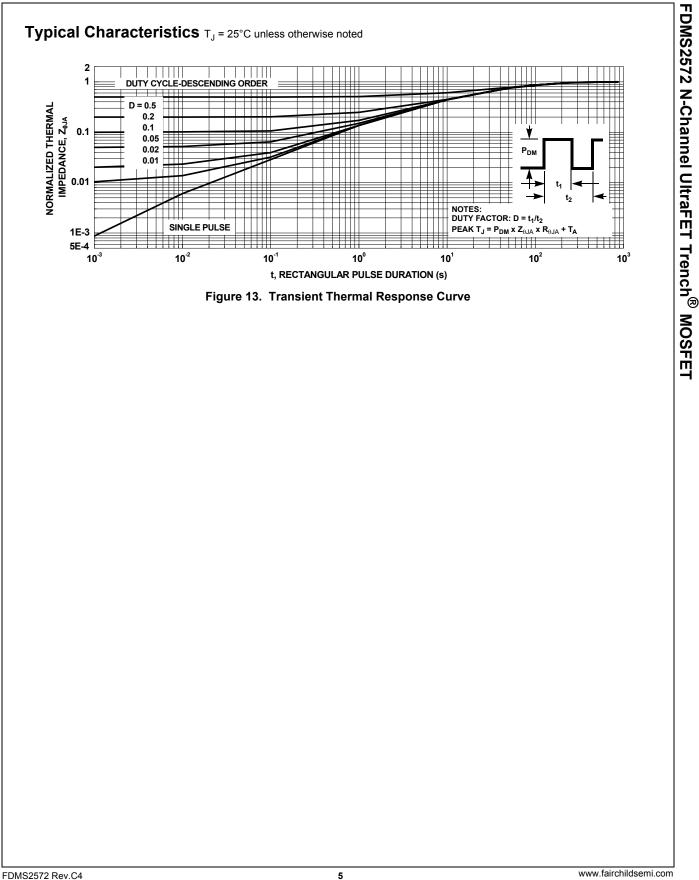
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2X 5.0 A -0.77 F 8 4.52 6.61 6.0 4.32 3.91-1 27 0.10 C 4 2X PIN #1 IDENT TOP VIEW 0.61 TYP 1.27 TYP RECOMMENDED LAND PATTERN -0.8 MAX // 0.10 C (0.25)____0.08 C ¢ 0.05 SIDE VIEW SEATING PLANE 3.86 🔕 0.64 0.44® 3.66 PIN #1 IDENT (OPTIONAL) 3.42 3.22 4.01? .10 i i 5 0.36-0.46 🚯 1.27 ⊕ 0.10 M C A B 3.81 ⊕ 0.05 M C 0 BOTTOM VIEW NOTES: ODES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229. DATED 11/2001. B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994 D. TERMINALS 5,6,7 AND 8 ARE TIED TO THE EXPOSED PADDLE MLP08GrevD

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